

STEP-UP DC/DC CONVERTER FOR WHITE LED BACK LIGHT

NO.EA-297-180704

OUTLINE

The R1206N071B is PWM control type step-up DC/DC converter IC with low supply current.

The R1206N071B is fully dedicated to drive White LEDs with constant current. Each of these ICs consists of an NMOS FET, an oscillator, a PWM comparator, a voltage reference unit, an error amplifier, a current limit circuit, an under voltage lockout circuit (UVLO), and an over-voltage protection circuit (OVP).

The R1206N071B can drive white LEDs in constant current with high efficiency by using an inductor, a diode, a resistor and capacitors as external components.

The LEDs current can be set by an external resistance value and can adjust the dimming of LEDs by CE pin according to the signal of PWM. Feedback voltage is 0.2V, therefore power loss by current setting resistance is small and efficiency is good. Maximum duty cycle is internally fixed, Typ. 91%. LEDs can be driven from low voltage. Protection circuits are the current limit of Lx peak current, the over voltage limit of output, and the under voltage lockout function.

It is controllable the dimming of LEDs quickly when the PWM signal (between 200Hz to 300kHz) input to CE pin. If the CE pin input is "L" in the fixed time (Typ. 0.5ms), the IC becomes the standby mode and turns OFF LEDs.

FEATURES

| Supply Current Standby Current | |
|-----------------------------------------------------|----------------------------------------------------|
| Input Voltage Range | 1.8V to 5.5V |
| Feedback Voltage | 0.2V |
| Feedback Voltage Accuracy | ±1.0% (±10mV) |
| • Temperature-Drift Coefficient of Feedback Voltage | ±150ppm/°C |
| Oscillator Frequency | Typ. 1.2MHz |
| Maximum Duty Cycle | Typ. 91% |
| Switch ON Resistance | Typ. 1.35Ω |
| UVLO Detector Threshold | Typ. 1.6V |
| Lx Current Limit Protection | Typ. 700mA |
| OVP Detector Threshold | Typ. 29.5V |
| Switching Control | PWM |
| LED dimming control | by external PWM signal (Frequency 200Hz to 300kHz) |
| Packages | SOT-23-6 |
| Ceramic capacitors are recommended | 0.22μF |

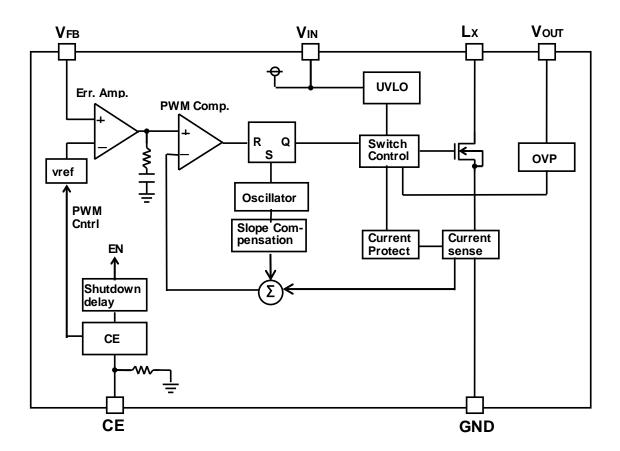
APPLICATIONS

· White LED Backlight for portable equipment

SELECTION GUIDE

| Product Name | Package | Quantity per Reel | Pb Free | Halogen Free |
|------------------|----------|-------------------|---------|--------------|
| R1206N071B-TR-FE | SOT-23-6 | 3,000 pcs | Yes | Yes |

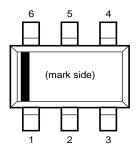
BLOCK DIAGRAM



NO.EA-297-180704

PIN DESCRIPTIONS

• SOT-23-6



• SOT-23-6

| Pin No | Symbol | Pin Description |
|--------|-----------------|-----------------------------------|
| 1 | Lx | Switching Pin (Open Drain Output) |
| 2 | GND | Ground Pin |
| 3 | V _{FB} | Feedback Pin |
| 4 | CE | Chip Enable Pin ("H" Active) |
| 5 | Vоит | Output Pin |
| 6 | VIN | Input Pin |

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ABSOLUTE MAXIMUM RATINGS

(GND=0V)

| Symbol | | Item | Rating | Unit |
|-----------------|-------------------------------|-------------------------------------------------|------------------------------|------|
| VIN | V _{IN} Pin Voltage | | -0.3 to 6.5 | V |
| Vce | CE Pin Voltage | | -0.3 to V _{IN} +0.3 | V |
| V _{FB} | V _{FB} Pin Voltage | | -0.3 to V _{IN} +0.3 | V |
| Vouт | Vоит Pin Voltage | | -0.3 to 32 | V |
| VLX | Lx Pin Voltage | | -0.3 to 32 | V |
| lıx | Lx Pin Current | | 1000 | mA |
| PD | Power Dissipation * | SOT-23-6 (JEDEC STD. 51-7 Test Land Pattern) | 660 | mW |
| Tj | Tj Junction Temperature Range | | -40 to 125 | °C |
| Tstg | Storage Temperature Ra | ange | -55 to 125 | °C |

^{*)} Refer to POWER DISSIPATION for detailed information.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Item | Rating | Unit |
|--------|-----------------------------|------------|------|
| Vin | Operating Input Voltage | 1.8 to 5.5 | V |
| Та | Operating Temperature Range | -40 to 85 | °C |

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

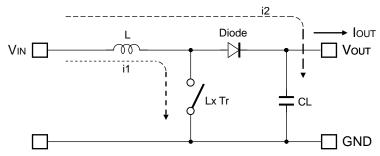
• R1206N071B (Ta=25°C)

| Symbol | Item | Conditions | Min. | Тур. | Max. | Unit |
|-----------------------------|-------------------------------------------------|-------------------------------------------------------------------------|------|-------------------------|------|------------|
| l oo | Supply Current | V _{IN} =5.5V, V _{FB} =0V, Lx at no load | | 0.5 | 1.0 | mA |
| Istandby | Standby Current | VIN=5.5V, VCE=0V | | 1.0 | 5.0 | μΑ |
| Vuvlo1 | UVLO Detector Threshold | V _{IN} falling | 1.5 | 1.6 | 1.7 | V |
| Vuvlo2 | UVLO Released Voltage | V _{IN} rising | | Vuvlo1 +0.1 | 1.8 | ٧ |
| Vceн | CE Input Voltage "H" | V _{IN} =5.5V | 1.5 | | | V |
| VCEL | CE Input Voltage "L" | V _{IN} =1.8V | | | 0.5 | V |
| Rce | CE Pull Down Resistance | VIN=3.6V | 600 | 1200 | 2200 | kΩ |
| V _{FB} | V _{FB} Voltage Accuracy | VIN=VCE=3.6V | 0.19 | 0.20 | 0.21 | V |
| ΔV _{FB} / ΔTa | V _{FB} Voltage Temperature Coefficient | V _{IN} =V _{CE} =3.6V, -40°C ≤ Ta ≤ 85°C | | ±150 | | ppm /°C |
| lгв | V _{FB} Input Current | VIN=5.5V, VFB=0V or VIN | -0.1 | | 0.1 | μΑ |
| Ron | Switch ON Resistance | V _{IN} =3.6V, I _{LX} =100mA | | 1.35 | | Ω |
| l∟xleak | Switch Leakage Current | VLX=30V | | 0 | 3.0 | μΑ |
| l∟xlim | Switch Current Limit | V _{IN} =3.6V | 400 | 700 | 1000 | mA |
| fosc | Oscillator Frequency | VIN=3.6V, VOUT=VFB=0V | 1.0 | 1.2 | 1.4 | MHz |
| Maxduty | Maximum Duty Cycle | VIN=3.6V, VOUT=VFB=0V | 86 | 91 | | % |
| V _{OVP1} | OVP Detector Threshold | VIN=3.6V, Vout rising | 28.7 | 29.5 | 30.3 | V |
| ΔV _{OVP1} / ΔTa | Vovp1 Voltage Temperature Coefficient | $V_{\text{IN}}=V_{\text{CE}}=3.6V, -40^{\circ}C \le Ta \le 85^{\circ}C$ | | ±150 | | ppm /°C |
| V _{OVP2} | OVP Released Voltage | VIN=3.6V, VOUT falling | | V _{OVP1} -1.55 | | V |

THEORY OF OPERATION

Operation of Step-Up DC/DC Converter and Output Current

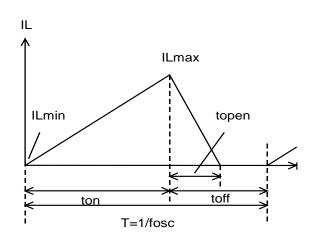
<Basic Circuit>

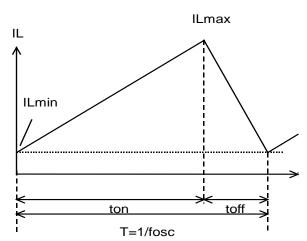


<Current through L>

Discontinuous mode

Continuous mode





There are two operation modes of the step-up PWM control-DC/DC converter. That is the continuous mode and discontinuous mode by the continuousness inductor.

When the transistor turns ON, the voltage of inductor L becomes equal to V_{IN} voltage. The increase value of inductor current (i1) will be

$$\Delta i1 = V_{IN} \times ton / L$$
 Formula 1

As the step-up circuit, during the OFF time (when the transistor turns OFF) the voltage is continually supply from the power supply. The decrease value of inductor current (i2) will be

$$\Delta i2 = (V_{OUT} - V_{IN}) \times t_{OPEN} / L$$
 Formula 2

At the PWM control-method, the inductor current become continuously when topen=toff, the DC/DC converter

operate as the continuous mode.

In the continuous mode, the variation of current of i1 and i2 is same at regular condition.

$$V_{IN} \times ton / L = (V_{OUT} - V_{IN}) \times toff / L$$
 Formula 3

The duty at continuous mode will be

The average of inductor current at tf = toff will be

$$IL(Ave.) = V_{IN} \times ton / (2 \times L)$$
......Formula 5

If the input voltage = output voltage, the lout will be

$$lout = V_{IN}^2 \times ton / (2 \times L \times V_{OUT})$$
......Formula 6

If the lout value is large than above the calculated value (Formula 6), it will become the continuous mode, at this status, the peak current (ILmax) of inductor will be

$$IL_{max} = l_{OUT} \times V_{OUT} / V_{IN} + V_{IN} \times ton / (2 \times L) ... Formula 7$$

$$IL_{max} = l_{OUT} \times V_{OUT} / V_{IN} + V_{IN} \times T \times (V_{OUT} - V_{IN}) / (2 \times L \times V_{OUT}) ... Formula 8$$

The peak current value is larger than the lout value. In case of this, selecting the condition of the input and the output and the external components by considering of ILmax value.

The explanation above is based on the ideal calculation, and the loss caused by Lx switch and the external components are not included.

The actual maximum output current will be between 50% and 80% by the above calculations. Especially, when the IL is large or V_{IN} is low, the loss of V_{IN} is generated with on resistance of the switch. Moreover, it is necessary to consider Vf of the diode (approximately 0.8V) about V_{OUT} .

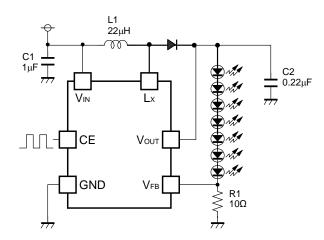
Soft-Start

The output of the error amplifier starts from 0V and the inrush current is suppressed when starting by the CE pin "H" input.

Moreover, the inrush current can be suppressed by gradually enlarging Duty of the PWM signal to the CE pin.

APPLICATION INFORMATION

• Typical Application Circuit



| C1 | CM105B105K06 |
|----|---------------|
| C2 | GRM21BR71H224 |
| L1 | LQH32CN220K53 |

Selection of Inductors

The peak current of the inductor at normal mode can be estimated as the next formula when the efficiency is 80%.

ILmax =
$$1.25 \times IOUT \times VOUT / VIN + 0.5 \times VIN \times (VOUT - VIN) / (L \times VOUT \times fosc)$$

When the start-up or dimming control by CE pin, transient current flows, the peak current must be equal or less than the current limit of the IC. The peak current should not beyond the rating current of the inductor.

When 4-7 LEDs are driven with V_{IN} =3.6V, the recommended inductance value is $10\mu H$ -22 μH .

Table 1 Peak current value in each condition

| | Cond | dition | | |
|---------|----------|-----------|--------|-----------|
| VIN (V) | Vout (V) | lou⊤ (mA) | L (μH) | Lmax (mA) |
| 3 | 14 | 20 | 10 | 215 |
| 3 | 14 | 20 | 22 | 160 |
| 3 | 21 | 20 | 10 | 280 |
| 3 | 21 | 20 | 22 | 225 |

Table 2 Recommended inductors

| L | Part No. | Rated | Size |
|------|---------------|--------------|--------------|
| (μH) | rait ivo. | Current (mA) | (mm) |
| 10 | LQH32CN100K53 | 450 | 3.2x2.5x1.55 |
| 10 | LQH2MC100K02 | 225 | 2.0x1.6x0.9 |
| 10 | VLF3010A-100 | 490 | 2.8x2.6x0.9 |
| 10 | VLS252010-100 | 520 | 2.5x2.0x1.0 |
| 22 | LQH32CN220K53 | 250 | 3.2x2.5x1.55 |
| 22 | LQH2MC220K02 | 185 | 2.0x1.6x0.9 |
| 22 | VLF3010A-220 | 330 | 2.8x2.6x0.9 |

Selection of Capacitors

Set $1\mu F$ or more value bypass capacitor C1 between VIN pin and GND pin as close as possible. Set $0.22\mu F$ or more capacitor C2 between VOUT pin and GND pin.

Note the Vout that depends on LED used, and select the rating of Vout or more.

Selection of SBD (Schottky Barrier Diode)

Select the diode with low VF such as Schottky type with low reverse current IR, and with low capacitance.

 Rated voltage(V)
 Part No.

 C1
 6.3
 CM105B105K06

 C2
 25
 GRM21BR11E224

 50
 GRM21BR71H224

 D1
 30
 CRS10I30A

 30
 RSX051VA-30

Table 3 Recommended components for R1206

LED Current setting

When CE pin input is "H" (Duty=100%), LED current can be set with feedback resistor (R1)

$$led = V_{FB} / R1$$

LED Dimming Control

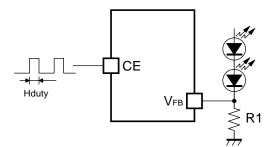
The LED brightness can be controlled by inputting the PWM signal to the CE pin. If the CE pin input is "L" in the fixed time (Typ.0.5ms), the IC becomes the standby mode and turns OFF LEDs.

The current of LEDs when the CE pin is "H" input (Duty=100%) is shown by the above expression. The current of LEDs can be controlled by Duty of the PWM signal of the input CE pin. The current of LEDs when High-Duty of the CE input is Hduty reaches the value as calculatable following formula.

$$I_{LED}=Hduty \times V_{FB}/R1$$

The frequency of the PWM signal is using the range between 200Hz to 300kHz.

When controlling the LED brightness by the PWM signal of 20kHz or less; The increasing or decreasing of the inductor current might be make a sounds in the hearable sound wave area. In that case, please use the PWM signal in the high frequency area.



Dimming control by CE pin input

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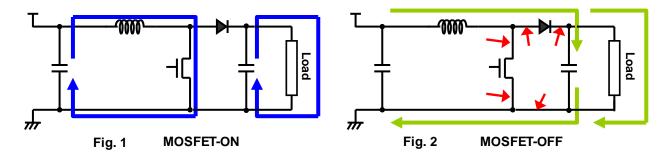
TECHNICAL NOTES

Current Path on PCB

The current paths in an application circuit are shown in Fig. 1 and 2. A current flows through the paths shown in Fig. 1 at the time of MOSFET-ON, and shown in Fig. 2 at the time of MOSFET-OFF. In the paths pointed with red arrows in Fig. 2, current flows just in MOSFET-ON period or just in MOSFET-OFF period. Parasitic impedance/inductance and the capacitance of these paths influence stability of the system and cause noise outbreak. So please minimize this side effect. In addition, please shorten the wiring of other current paths shown in Fig. 1 and 2 except for the paths of LED load.

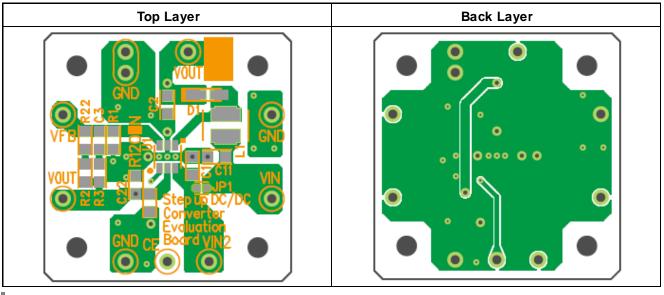
Layout Guide for PCB

- Please shorten the wiring of the input capacitor (C1) between V_{IN} pin and GND pin of IC. The GND pin should be connected to the strong GND plane.
- · The area of Lx land pattern should be smaller.
- The wiring between Lx pin and inductor and diode should be short and please put output capacitor (C2) close to the cathode of diode.
- · Please make the GND side of output capacitor (C2) close to the GND pin of IC.



PCB Layout

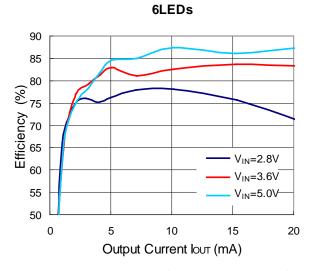
R1206N (PKG: SOT-23-6pin)

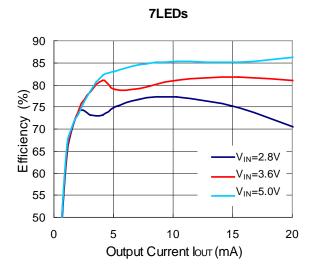


U1-■ indicates the position of No.1 pin.

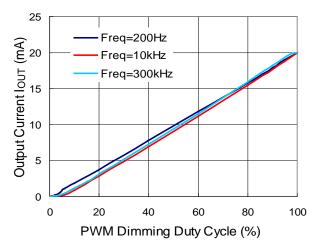
TYPICAL CHARACTERISTICS

1) Efficiency vs. Output Current Characteristics

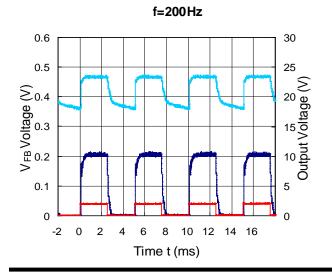


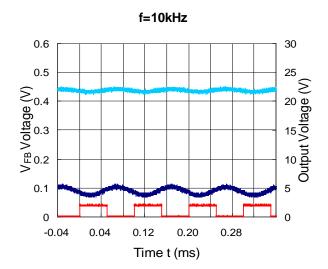


2) PWM Dimming Duty Cycle vs. Output Current(R1=10Ω)

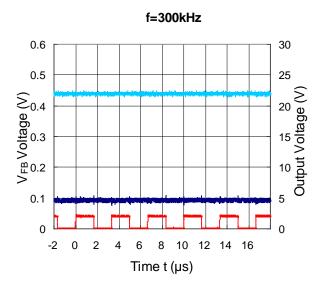


3) Output Current Ripple during PWM Dimming

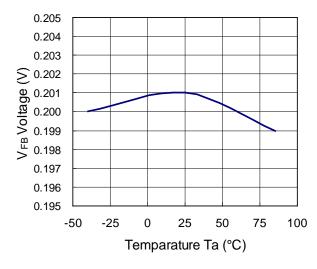




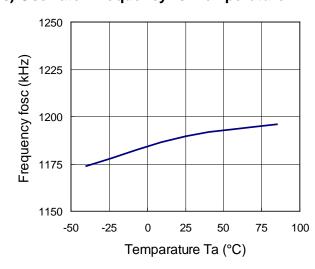
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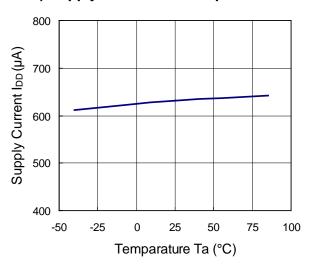
4) VFB Voltage vs. Temperature



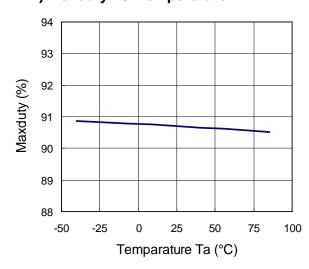
6) Oscillator Frequency vs. Temperature



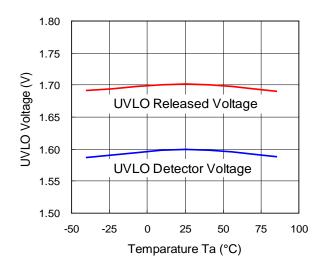
5) Supply Current vs. Temperature



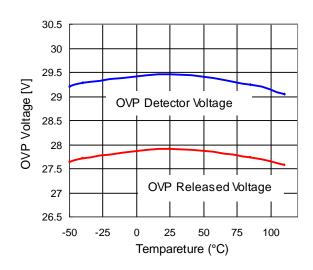
7) Maxduty vs. Temperature



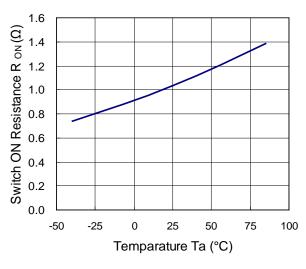
8) UVLO Output Voltage vs. Temperature



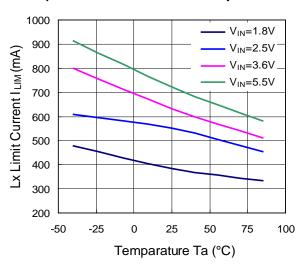
9) OVP Voltage vs. Temperature



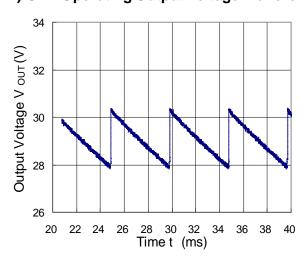
10) Switch ON Resistance vs. Temperature



11) Lx Current Limit vs. Temperature



12) OVP Operating Output Voltage Waveform



Ver A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

| Item | Measurement Conditions (JEDEC STD. 51-7) | |
|------------------|-------------------------------------------------------------------------------------------------|--|
| Environment | Mounting on Board (Wind Velocity = 0 m/s) | |
| Board Material | Glass Cloth Epoxy Plastic (Four-Layer Board) | |
| Board Dimensions | 76.2 mm × 114.3 mm × 0.8 mm | |
| Copper Ratio | 1st Layer : Less than 95% of 50 mm Square 2nd, 3rd, 4th Layers: Approx. 100% of 50 mm Square | |
| Through-holes | φ 0.3 mm × 7 pcs | |

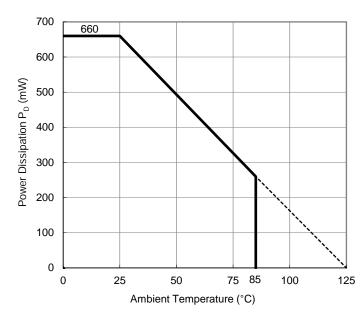
Measurement Result

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

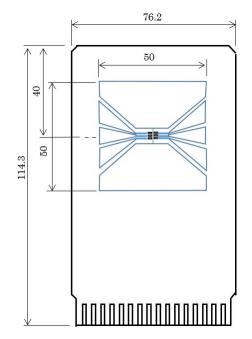
| Item | Measurement Result | |
|------------------------------------------|--------------------|--|
| Power Dissipation | 660 mW | |
| Thermal Resistance (θja) | θja = 150°C/W | |
| Thermal Characterization Parameter (ψjt) | ψjt = 51°C/W | |

 θ ja: Junction-to-ambient thermal resistance.

ψjt: Junction-to-top of package thermal characterization parameter

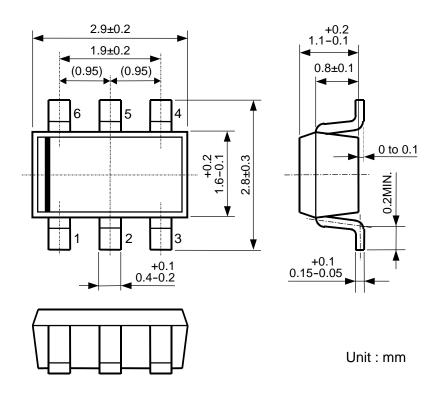


Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

Ver. A



SOT-23-6 Package Dimensions



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- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact our sales or our distributor before attempting to use AOI.
- 11. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



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